

Basic:

Voltage divider: $V_2 = \frac{R_2}{R_1 + R_2}$

Capacitor: $Z_C = \frac{1}{j\omega C}$, $I = C \frac{dV}{dt}$, $E = \frac{1}{2} CV^2$

LCR: resonance: $\omega = \frac{1}{\sqrt{LC}}$

Superposition: Short voltage, open current, analyze the thing, add.

Voltage to current: $I_{IS} = V_{VS}$, $R_{CS} = \frac{1}{RVS}$

OP AMP: Inverting Amp: $A = \frac{V_{out}}{V_{in}} = -\frac{R_F}{R_{in}}$

Summing Inverting Amp: $V_{out} = -R_F \left(\frac{V_1}{R_1} + \frac{V_2}{R_2} + \frac{V_3}{R_3} \right)$

Subtraction: Inverting amp with voltage divider on plus: $V_{out} = V_{plus} \frac{R_G}{R_{in,plus} + R_G} \cdot \frac{R_{in,minus} + R_F}{R_{in,minus}} - V_{minus} \frac{R_F}{R_{in,minus}}$

H response: $H(\omega) = \frac{V_{out}}{V_{in}}$

Integrator: R_F is a capacitor, $V_{out} = -\frac{1}{R_{in}C} \int_0^t V_{in} dt$

Detailed amplification: op amp

diff: $V_{out} = A_{diff}(V_+ - V_-)$

CM: $V_{out} = A_{CM}(V_+ + V_-)$

total amplification: $V_{out} = A_{diff}(V_+ - V_-) + A_{CM}(V_+ + V_-)$

CMRR: common mode rejection ratio: $\frac{A_{diff}}{A_{CM}}$, $20 \log(CMRR) dB$

Gain Bandwidth Product: Gain \cdot Bandwidth, $A \cdot f$

Constant gain at low frequency, decreases linearly because slew rate at high frequency

knee frequency: $\omega = \frac{1}{RC} = \frac{1}{T} = \frac{1}{2\pi RC}$, $\Rightarrow H(\omega) = \frac{1}{\sqrt{2}}$, $-3dB$

above knee frequency: $H(\omega) = \frac{1}{\omega RC}$, $-20dB$ per decade

high pass: $H(\omega) = \omega RC$, $20dB$ per decade, slope multiplied by N stages.

Slew rate: $= dV_{out}/dt$

ex: $SR = 1V/\mu s$, pulse $0 - 2V$, $T = 2\mu s$, $1V$ triangle wave

good sine wave: $SR \geq 2\pi f V_0$

DIODES: forward bias, apply $+V$ to holes, push holes(p) and electrons(n) together, get conduction

IV: $I = I_0(e^{\frac{V}{V_t}} - 1)$

Thermal voltage: $V_t = \frac{kT}{e} = 26mV$

Threshold voltage: $V_{th} = 0.7V$

Reverse saturation current: I_0 around 10^{-10}

For $V \gg V_t$, $I = I_0 e^{\frac{V}{V_t}}$

Differential resistance: $r_D = \frac{V_t}{I}$ (I from above equation)

Basic DR circuit: $V_B = IR + V_D$, $I = I_D = I_0 e^{\frac{V}{V_t}}$

Graphically solve: $V_B = I_0 e^{\frac{V}{V_t}} R + V_D$, $V_B - V_D = I_0 e^{\frac{V}{V_t}}$

Approximate analytic solution: $V_D = V_{th} = 0.7V$, $I = \frac{V_B - 0.7}{R}$

Linearization: $r_D = \frac{V_t}{I_D}$, can treat as this resistor for an AC signal, just account for DC offset with superposition.

find I with DC (probably $\frac{V_B - 0.7}{R}$), and $r_D = \frac{0.026}{I}$, then add AC signal with r_D

Rectification: $P = V_{th} I$ AM: through diode and R and past C to filter out frequency, left with audio. Also LED and solar cell.

ZENER DIODE: width of depletion region changed with doping

Breakdown: at $V = V_{breakdown} = V_Z$

IV: turn on at $V_{th} = 0.7$, reverse turn on at $-V_Z$, typically used backwards, so flip V, expect $+ | < -$

$V < V_Z \Rightarrow r_Z = \frac{dV}{dI} = \infty$ OR $V \geq V_Z$, $r_Z = \frac{dV}{dI} = 0$

$I = I_0 e^{\frac{V - V_Z}{V_t}}$

Basic ZDR circuit:

Graphical: $V_{Bat} - IR = V_Z(I)$

Approx analytical assume $V_Z = \text{constant}$, $I = \frac{V_B - V_Z}{R}$

Voltage stabilization: $V_{out} = V_Z = \text{constant}$, wastes power, must have significant R_{Load}

Voltage clipper: two parallel to load, facing away, V clipped at $V_Z + V_{th}$

Voltage shifter: one series, cuts V_Z off of input

npn, E+ arrow in top, holes flow in E, most make it to C, need current E to B, $V_{BE} < 0$

npn, E+ arrow out bot, holes flow out E, most come from C, need current B to E, $V_{BE} > 0$

common base: in in E, out out C, grounded out B

common emitter: in out B, out out C, grounded in E

common collector: in out B, out in E, grounded out C

$$I_C = \alpha I_E$$

$$I_C = \beta I_B$$

$$I_E = (\beta + 1)I_B$$

$$\beta = \alpha / (1 - \alpha)$$

base \ll diffusion length

Equivalent:

Current from B, $\alpha' I'_C$ to E, $\alpha I'_E$ to C

Diode to B, I'_E from E, I'_C from C ($\alpha' < \alpha$)

simplifies to:

diode E to B, current out B, current B to C $\alpha I_E = \beta I_B$

npn is just flipped, $I_C = \alpha I_E$, diode B to E

graph output characteristic I_C vs V_{CE} ,

steep start goes (nearly) flat, $I_C = \beta I_B$, flat section goes up with I_B

linear (small signal): output, current, effect \propto input, voltage, cause: RCL, non: Diode, BJT, FET

small signal can count VCC as GND

C-B-E, equiv current αI_E - Diode I_E , near opp, $r_E + DC$, small signal r_E , $r_E = V_t / I_E = 26mV / I_E$

Common E: E grounded, B input, C output and RC to VCC,

$$I_C = -V_{CE} / R_C + V_{CC} / R_C = V_{CC} / R_C - 1 / R_C \quad (I_C = 0 \text{ at } V_{CE} = V_{CC})$$

$$\text{solve } I_C = \beta I_B = -V_{CE} / R_C + V_{CC} / R_C$$

saturation fully on at top left, $V_{CE} \approx 0.1 - 0.2V$

forward active linear in middle, $I_C = \beta I_B$, $V_{BE} \approx 0.7V$

cutoff off at bottom, $V_{BE} < 0.7V$, $I_B = I_C = 0$, CE impedance $= \infty$

Quiescent point around middle of forward active region/dynamic range,

frequently middle of $I_C = V_{CC} / R_C - 1 / R_C$, determined by DC bias network

find B current, find C current, find CE voltage (output voltage)

Primitive common E

$$\text{Voltage amplification } A_{VOC} = V_{in} / V_{out} = -\beta i_B R_C / i_E r_E = -\beta i_B R_C / (\beta + 1) i_B + r_E \approx -R_C / r_E$$

$$\text{Current amplification } A_{ISC} = i_{out} / i_{in}$$

$$\text{Input impedance } Z_{in} = V_{in} / I_{in} = r_E i_E / i_B = r_E (\beta + 1) i_B = \beta r_E$$

$$\text{Output impedance } Z_{out} = V_{out} / I_{out} = R_C I_C / I_C = R_C$$

Emitter follower, RB to VCC, RE to GND, $V_{out} = V_{in} - V_{BE}$,

$Z_{in} \approx \beta R_E$ (high), $Z_{out} \approx R_E$ (low), $A_{VOC} \approx 1$ (low), $A_{ISC} \leq \beta$ (high)

Non-idealities of BJTs

Finite output impedance (current source), $r_{CE} \neq \infty$

output characteristic graph isn't flat, but sloped with r_{CE}^{-1} ,

meets at Early Voltage $\approx -10V$ to $-100V$

$\beta = \Delta I_C / \Delta I_B$ increases with V_{CE} due to base width modulation

$$I_C = \alpha I_0 e^{V_{BE} / V_t} (1 + (V_{CE} / V_{Early}))$$

$$\text{slope} = r_{CE}^{-1} = I_C / (V_{Early} + V_{CE})$$

Breakdown of CB at high VCE, reverse breakdown of neglected BC diode comes into play, out char slopes increase

100V for Si, increasing order Ge, Si, GaAs, SiC, GaN, C

DIFFERENTIAL AMPLIFIER, used in op amp and Emitter Coupled Logic

C is outputs and R_C to $+V_{CC}$, B is inputs, E connects and shares R_E to GND

if input 1 is the input, output 1 is inverting

single input, single output, opposite sides, $A = R_C/(2r_E)$, differential output gives $A = R_C/r_E$

differential input and output $A = 2R_C/r_E$; Q-point $V_{CE} \approx V_{CC} - \beta I_{B1}(R_C + 2R_E)$

$\Delta I_{C1} = -\Delta I_{C2}$, so total current is constant, I_{RE} is constant, V is constant, Virtual Ground

Input Output Gain $r_E = V_t/I_E = 26mV/I_E$

single single $R_C/(2r_E)$

single differential $R_C/(r_E)$

differential differential $2R_C/(r_E)$

FLIP FLOP, SRAM(fast, power hungry, small)

C connects to V_{CC} through R_C and to other B through R_B . $P \approx V_{CC}^2/R_C$

R_C limits current flow while on, R_B stops other transistor from getting turned on.

ASTABLE FLIP FLOP, Multivibrator $R_B \gg R_C$

same as above, but replace R_B with capacitor C , and have resistor R_B from the other side (B) of C to V_{CC}

Assume T1 on T2 off, $\tau = RC = R_{B1}C_1$, $T = 2\tau = 2R_B C$, change f with R_B (could do C)

C2 charged to $V_{CC}-0.7V$, C1 charge slow RB1, T2 VBE hit 0.7 turn on, T2 VC=0, C2 charge brings VB1 negative

CURRENT MIRROR

T1 and T2 share E GND and B, T1 has CB shorted and R_C above that, load on T2 C

shared V_{BE} so turned on the same, $I_{RC} = (\beta + 2)I_B$, $I_{Load} = \beta I_B$, $I_{Load} \approx I_{RC}$

CLASS A AMPLIFIERS, basic, quality, high power draw

E GND, B in, B R_B to V_{CC} , C out, C R_C to V_{CC}

Q point power $P = I_C * V_{CE}$, constant power draw, good pre amp

CLASS B AMPLIFIER, push pull, crossover distortion, low power,

signal split bwtween two, top is NPN (normal), bottom is PNP (inverting), stacked between V_{CC+} and V_{CC-} less than 0.7V is lost, crossover distortion

CLASS AB AMPLIFIER, better push pull, low distortion, med-low power,

add caps to isolate each input and resistors + diodes to bias (1.4V between them), both have $V_{BE} = 0.7V$

CLASS C AMPLIFIER, pulse amplifier

CLASS D AMPLIFIER, digital audio quality, low power

triangle wave at 100kHz, gets compared to audio. Audio higher, high FET drives high, triangle higher, low fet drives low, gets smothed to 20kHz range by inductor

DARLINGTON TRANSISTOR

C is shared, E connects to next B. $V_{BE} = 1.4V$, $\beta = \beta^2$, $V_{CE} = V_{BE2} + V_{CE1} \geq 0.9V$

T2 doesn't saturate, can be good for high speed, used for RF

1 Intro to Electronics S 2024 Crib Sheet Exam Final Hayden Fuller

(power supply and LCD excluded)

Gate charge induces opposite charge in semiconductor

electrons Source to Drain, current Drain to Source

L_G is length between S and D, W_G is how "deep" the whole thing is extruded

$V_{GS} > 0$ negative charge induced in channel, $V_{GS} < 0$ positive charge induced in channel,

Threshold Voltage: Voltage needed to induce mobile charges in channel, allow current flow

V_{th} can be anything, above or below zero,

$V_{GS} > V_{th}$ turns on

I_D vs V_{DS} :

1) ohmic

Increased V_{GS} increases slope

Slope = $dI_D/dV_{DS} = 1/R_{ON/OFF}$

$I_D = k(V_{GS} - V_{th})V_{DS}$; $k = k'W_G/L_G$

2) Intermediate

$I_D = k[(V_{GS} - V_{th})V_{DS} - \frac{1}{2}V_{DS}^2]$

linear starts to saturate

caused by pinch off on D side of channel when V_{DS} too high

$V_{DS} = V_{GS} - V_{th}$ has slope 0

3) Saturation

$V_{DS} \geq V_{GS} - V_{th}$

V_{DS} no longer contributes past $V_{GS} - V_{th}$, so replace in equations

$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2$

I_D VS V_{GS}

parabola $I_D = \frac{1}{2}k(V_{GS} - V_{th})^2$, bottom is zero at V_{th}

Load Line of amp

Common S (GND), R_D from D to VCC

$I_D = (V_{CC} - V_{DS})/R_D$

hits I_D at V_{CC}/R_D ; hits V_{DS} at VCC

Dynamic region and Q point in middle, under top curve of constant V_{GS}

Which regime to use? SATURATION!

linear is dependent on both V_{GS} and V_{GS} , saturation current is only dependent on V_{GS}

SYMBOLS

4 terminal, basic FET symbol with arrow at bulk

in from bulk to fet for N-channel

out from fet to bulk for P-channel

Bulk allows the tuning of V_{th} , usually connected to S for 3 terminals

3 terminal

N-channel: e from S to D, I from D to S

Arrow out from G to S

Enhancement Mode: normally OFF, $V_{th} > 0$, has gap in channel of symbol

Depletion Mode: normally ON, $V_{th} < 0$, no gap in channel of symbol (default)

P-channel: h from S to D, I from S to D

Arrow in from S to G

Enhancement Mode: normally OFF, $V_{th} < 0$, has gap in channel of symbol

Depletion Mode: normally ON, $V_{th} > 0$, no gap in channel of symbol (default)

2 DIGITAL SYMBOLS

N-channel enhancement $V_{th} > 0$ regular digital
P-channel enhancement $V_{th} < 0$ inverted digital
Complementary MOS!

DC-BIASING OF FET

FIND Q POINT OF CIRCUIT (I_D and V_{DS})

$$I_G = 0; I_D = I_S$$

EX 1:

N-channel common S, RD to VCC, D out

R1 R2 divider on G

C on input and output

$$V_{GS} = V_G$$

$$V_{GS} = R2/(R1 + R2) \text{ (voltage divider)}$$

$$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2 \text{ (saturation)}$$

2 equations 2 unknowns, solve

verify we're in saturation with $V_{DS} = VCC - R_D I_D \geq V_{GS} - V_{th}$

EX 2:

N-channel common NONE, RD to VCC, RS to GND, D output

R1 R2 divider on G

C on input and output

$$V_{GS} = V_G - V(R_S)$$

$$V_{GS} = R2/(R1 + R2) - R_S I_D \text{ (voltage divider + KVL)}$$

$$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2 \text{ (saturation)}$$

2 equations 2 unknowns, solve, system of equations, quadratic (Right solution, $V_{GS} > V_{th}$)

verify we're in saturation with $V_{DS} = VCC - (R_D + R_S)I_D \geq V_{GS} - V_{th}$

EX 3:

N-channel common S, RD to VCC, D output

FEEDBACK: RG from D to G

C on input and output

Current through RG is zero! no G current, assume no current from input source

$$V_{GS} = V_G$$

$$V_{GS} = V_D = VCC - I_D R_D \text{ (no voltage difference)}$$

$$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2 \text{ (saturation)}$$

2 equations 2 unknowns, solve, system of equations, quadratic (Right solution, $V_{GS} > V_{th}$)

verify we're in saturation with $V_{DS} = VCC - R_D I_D \geq V_{GS} - V_{th}$

EQUIVALENT CIRCUIT OF FET (n-channel)

common S, left input V_{GS}

D to S current source $I_D = \frac{1}{2}k(V_{GS} - V_{th})^2$

Small Signal Linearization:

D to S current source $i_D = g_m V_{GS}$

$$g_m = \frac{dI_D}{dV_{GS}} \text{ (Siemens, Transconductance)}$$

$$g_m = k(V_{GS} - V_{th}); (V_{GS} \text{ of Q-point})$$

Capacitor like input, no input DC current, no power! Great for low power signals

$$i_D = g_m v_{GS}$$

Non Ideal Output Impedance

Small signal adds R_{DS} parallel to current source

I_D VS V_{GS} adds slope $1/R_{DS} > 0$

non ideal current source, finite output impedance R_{DS}

3 FET AMPLIFIERS

Common SOURCE

RD to VCC, D out

Basic bias network voltage divider optional

Common DRAIN

RS to GND, S out

Basic bias network voltage divider optional

SOURCE FOLLOWER

Common GATE

S input (arrow), D output

Current Amplification 1.0

CURRENT FOLLOWER

ANALYSIS

R source and R load don't matter

$C \rightarrow \infty$ so that $Z_C = 1/(j\omega C) = 0$

realistically, let past all relevant frequencies

Small Signal:

Anything to VCC goes to GND instead

basic common S with basic voltage divider input bias

R1 and R2 G to S; current source and RD from D to S

$$z_{in} = R1 || R2 = 1/(1/R1 + 1/R2)$$

$$Z_{out} = R_D \text{ or } R_D || R_{DS} \text{ for non ideal}$$

$$A_{ISC} = i_{out}/i_{in} = g_m v_{GS}/(v_{GS}/(R1 || R2)) = g_m(R1 || R2); \text{ large } R1 \text{ and } R2 \text{ means large } A_{ISC}$$

$$A_{VOC} = v_{out}/v_{in} = g_m V_{GS} R_D / V_{GS} = g_m R_D$$

Add source resistance

goes in series with current source

$$z_{in} = R1 || R2$$

$$z_{out} = R_D$$

$$A_{ISC} = g_m V_{GS} / ((V_{GS} + R_S g_m V_{GS}) / (R1 || R2)) = g_m(R1 || R2) / (1 + g_m R_S); R_S \text{ reduces amplification}$$

$$A_{VOC} = g_m V_{GS} R_D / (V_{GS} + R_S g_m V_{GS}) = g_m R_D / (1 + g_m R_S); R_S \text{ reduces amplification}$$

Common Drain source follower (with basic voltage divider bias)

R1 and R2 from G to GND

Drain is grounded, so current source from GND to S (parallel to RS)

$$z_{in} = R1 || R2$$

$$z_{out} = R_S$$

$$A_{ISC} = g_m V_{GS} / (V_{GS} / (R1 || R2)) = g_m(R1 || R2); \text{ for high } R1 \text{ and } R2, A_{ISC} \gg 1 \text{ (large)}$$

$$A_{VOC} = g_m V_{GS} R_S / (V_{GS} + g_m V_{GS} R_S) = g_m R_S / (1 + g_m R_S); \text{ for large } R_S, A_{VOC} \approx 1$$

S voltage follows G voltage

KEEP IN MIND

inverting also exists, sometimes negative is left out of A_{VOC} , doesn't really matter for audio

Smaller is better! $k = k' W_G / L_G$, shorter L_G (length between S and D) is proportional to better amplification

MILLER CAPACITANCE

C_{GS} , C_{DG} , C_{DS}

C_{DG} is most important

Modification: we replace it with C_M G to S and C_{MO} D to S

$$C_M = (1 + A_{VOC}) C_{DG} \text{ for } R_L = \infty, C_M = (1 + A_V) C_{DG} \text{ otherwise}$$

$$4 \quad C_{MO} = ((1 + A_{VOC}^{-1})C_{DG} \approx C_{DG}$$

$$\tau_{in} = R_{in}C_M; \tau_{out} = R_L C_{MO}; (\text{R is counting anything not parallel})$$

$$\tau_{out} \text{ is smaller, can neglect } C_{MO}$$

$$\omega_{knee} = 1/(RC_M), \text{ better response with reduced R, low output impedance pre amp (source follower)}$$

FET AS SWITCH

dim with PWM, better because no resistive power loss

perfect switch is $R_{ON} = 0\Omega$ and $R_{OFF} = \infty\Omega$

OFF is saturation

$$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2$$

$$V_{GS} < V_{th} \rightarrow I_D = 0 \rightarrow R_{OFF} = \infty, \text{ perfect off state}$$

ON is ohmic

$$I_D = \frac{1}{2}k(V_{GS} - V_{th})^2$$

$$R_{ON} = 1/(k(V_{GS} - V_{th})) > 0, \text{ non perfect on state}$$

minimize R_{ON} : $V_{GS} \gg V_{th}$; geometry of fet: wide W_G , short L_G , increase k, decrease R_{ON}

transition from mechanical to FETs

INTEGRATED CIRCUITS CMOS

n-channel: arrow out, non inverting, $V_{th} > 0$

p-channel: arrow in, inverting, $V_{th} < 0$

both enhancement

inverter: p to VCC, n to GND

static power consumption is zero

not quite because 1) caps charge and discharge with resistance and 2) R_{ON} isn't quite zero

ICONIC CIRCUITS

Memory:

horizontal word lines enable access, point into above cells

vertical bit line(s) read and write data to cells

Flip Flop:

4 FETs for bistable flip flop; p on top, n on bottom, middle of them is input to other side

SRAM:

Static Random Access Memory

Each (or one) side output has an access transistor (n), whose input comes from the word line, allowing the bit line to read or write when on

6 transistors (4n 2p); fast; VOLATILE

DRAM:

Dynamic RAM, storage is a capacitor, same word line, bit line, and access n transistor, but now just a grounded cap to store.

needs to be refreshed every 64ms or so, still VOLATILE

SRAM is better, DRAM is cheaper

FLASH:

Gate M is completely surrounded by Oxide, stores that charge for 10-20 years, (+ on M for n-channel)

need a "flash" of charge through the insulator to change it, high voltage pulse between S and D; NON VOLATILE

5 BACK WORK

Example 1: work backwards

n-channel common NONE, RD and RS, output from D through R3, basic bias voltage divider R1 R2

Caps on input, output, and S to GND (RE); RS is shorted at AC

$k = 20mA/V^2$, $V_{th} = 2V$, $I_D = 20mA$, $V_{DS} = 5V$, $VCC = 10V$

a) assume $V_D = 6V$, determine R_D and R_S

$$V_S = V_D - V_{DS} = 6V - 5V = 1V$$

$$R_S = V(R_S)/I_D = 1V/20mA = 50\Omega$$

$$R_D = V(R_D)/I_D = 4V/20mA = 200\Omega$$

b) assume $R1 + R2 = 100k\Omega$, determine them

solve for $V_{GS} = \sqrt{2I_D/k} + V_{th}$

$$V_{GS} = \sqrt{2 * 20mA/(20mA/V^2)} + 2V = 3.41V$$

$$\text{Voltage divider: } V_G = VCC * R2/(R1 + R2); 3.41V + 1V = 10V * R2/100k\Omega; R2 = 44.1k\Omega; R1 = 55.9k\Omega$$

c) what is the common name for this? what class amplifier?

Common Source, Class A amplifier

d) assume $R3 = 200\Omega$, draw small signal equivalent, give transconductance g_m

G has R1 R2 to GND, V_{gs} to S; D has current source $g_m V_{GS}$ to S, RD to GND, and R3 to output

$$g_m = k(V_{GS} - V_{th}) = 20mA/V^2(3.41V - 2V) = 28.2 \text{ mSiemens}$$

e) A_{VOC} , expression and value

$$v_{in} = V_{GS}; v_{out} = g_m V_{GS} R_D$$

$$A_{VOC} = g_m V_{GS} R_D / V_{GS} = g_m R_D$$

$$A_{VOC} = 28.2mS * 200\Omega = 5.64$$

f) A_{ISC} , expression and value

$$i_{in} = v_{in}/(R1||R2) = V_{GS}/(R1||R2)$$

$$i_{out} = g_m V_{GS} R3^{-1}/(R_D^{-1} + R3^{-1}); \text{ (current divider)}$$

$$A_{ISC} = g_m V_{GS} R3^{-1}/(R_D^{-1} + R3^{-1})/(V_{GS}/(R1||R2)) = g_m R3^{-1}/(R_D^{-1} + R3^{-1})(R1||R2)$$

$$A_{ISC} = 28.2 * 1/2 * 24.7 = 348$$

g) draw small circuit equivalent, calculate $A_V = V_{Load}/V_{SS}$, expression and value

same as before but add source $V_S S$ and input resistance (series with load) R_{SS} ; and add R_L

$$V_{GS} = V_{SS}(R1||R2)/(R_{SS} + (R1||R2))$$

$$V_{SS} = V_{GS}(R_{SS} + (R1||R2))/(R1||R2)$$

$$V_{Load} = RL * i_D * (R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1}) \text{ (resistance * current divider)}$$

$$V_{Load} = RL * g_m V_{GS} * (R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1})$$

$$A_V = V_{Load}/V_{SS} = [g_m V_{GS} RL((R3 + RL)^{-1})/(R_D^{-1} + (R3 + RL)^{-1})]/[V_{GS}(R_{SS} + (R1||R2))/(R1||R2)]$$

$$A_V = g_m(R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1}) * R_L(R1||R2)/(R_{SS} + (R1||R2))$$

$$A_V = 1.56$$

h) calculate $A_I = i_{Load}/i_{SS}$, expression and value

$$i_{Load} = g_m V_{GS}(R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1})$$

$$i_{SS} = V_{GS}/(R1||R2)$$

$$A_I = [g_m V_{GS}(R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1})]/[V_{GS}/(R1||R2)] = (R1||R2)g_m(R3 + RL)^{-1}/(R_D^{-1} + (R3 + RL)^{-1})$$

$$A_I = 232$$

Example 2: True/False

(a) An astable flip-flop circuit can be made by using BJTs but not by using FETs.

False, can be made with BJTs or FETs

(b) A CMOS dynamic random access memory (DRAM) 1-bit memory cell has two complementary MOS transistors and one capacitor.

False, 1 bit of DRAM requires one transistor and one capacitor

(c) The first integrated circuit was made with BJTs.

True, though FETs are more popular now, they're newer than BJTs

(d) At the present time, integrated circuits made with BJTs are relatively rare.

True, BJTs are power hungry, not often a need for them when CMOS technology can do it with less

(e) The following equation may be reasonable for some specific circumstances: $g_m = 1/3k$, where g_m is the transconductance of an FET, and k is the k -value of the FET.

False, g_m is in Siemens, while k is in mA/V^2